

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
KIMIIHIKO SUDO	01/06/2016
KAZUKI TAKEICHI	01/06/2016
TAKAKO HAYAKAWA	01/06/2016
YUTA ONOBU	01/08/2016
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14997464
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SIGNATURE:	/John D. Henkhaus/
DATE SIGNED:	01/15/2016
Total Attachments: 1	

ASSIGNMENT FOR PATENT APPLICATION

Whereas, I/we the undersigned inventor(s) have invented certain improvements as set forth in the patent application entitled:

LAMINATED FILM-PACKED HARD DISK DRIVE FOR HERMETIC SEALING

Whereas, **HGST Netherlands B.V.**, having a place of business at Herikerbergweg 238, Luna Arena, 1101 CM Amsterdam, The Netherlands (hereinafter referred to as "HGST"), desires to acquire the entire right, title and interest in the said application and invention, and to any United States and foreign patents to be obtained therefore;

Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, I/we, the above named, hereby sell, assign, and transfer to HGST, its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing of said United States application, and we request the Commissioner of Patents to issue any Letters Patent granted upon the inventions set forth in said application to HGST, its successors and assigns; and we hereby agree that HGST may apply for foreign Letters Patent on said invention and we will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by HGST.

Signed on the date(s) indicated beside my (our) signature(s).

- 1) Signature: Kimihiko Sudo Date: 2016.1.6
Typed Name: KIMHIKO SUDO
- 2) Signature: Kazuki Takeichi Date: 2016.1.6
Typed Name: KAZUKI TAKEICHI
- 3) Signature: 早川 貴子 Date: 2016.1.6
Typed Name: TAKAKO HAYAKAWA
- 4) Signature: 大信 祐太 Date: 2016.1.8
Typed Name: YUTA ONOBU